INFORMATION SUSCIONATION STATEMENT BY APPLICANT

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APPLICANT	
Anette BUSCHKA et al.	
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. SEND TO: Assistant Commissioner for Patents, Washington, D.C. 20231.